

EVVOSEMI[®]

THINK CHANGE DO



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

Product Specification

▶ Domestic	Part Number	APM4953
▶ Overseas	Part Number	APM4953
▶ Equivalent	Part Number	APM4953

EV is the abbreviation of name EVVO

-30V P-Channel MOSFET

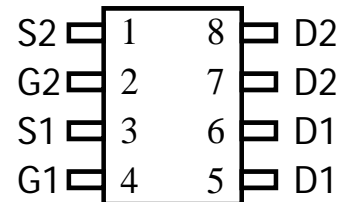
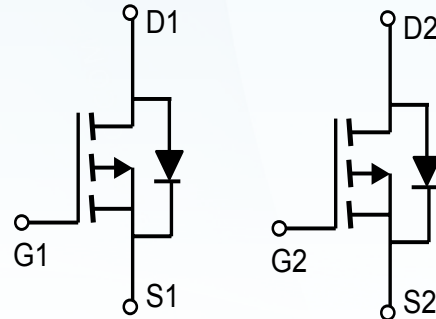
Features

$V_{DS} (V) = -30V$

$I_D = -5.3A (V_{GS} = 10V)$

$R_{DS(ON)} < 41m\Omega (V_{GS} = -10V)$

$R_{DS(ON)} < 75m\Omega (V_{GS} = -4.5V)$



Absolute Maximum Ratings ($T_A=25^\circ C$, unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	-30	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current (Continuous)	-5.3	A
I_{DM}	Drain Current (Pulsed) ^a	-20	A
P_D	Total Power Dissipation @ $T_A=25^\circ C$	2.0	W
I_S	Maximum Diode Forward Current	-1.9	A
T_j, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ C$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient (PCB mounted) ^b	50	$^\circ C/W$

a: Repetitive Rating: Pulse width limited by the maximum junction temperature.
b: 1-in² 2oz Cu PCB board

-30V P-Channel MOSFET

Electrical Characteristics (T_A=25°C, unless otherwise noted)

Symbol	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250uA	-30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V	-	-	-1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
ON CHARACTERISTICS^b						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250uA	-1	-1.5	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-5.3A	-	38	41	mΩ
		V _{GS} =-4.5V, I _D =-3.9A	-	59	75	
g _{FS}	Forward Transconductance	V _{DS} =-10V, I _D =-5.3A	-	11	-	S
DYNAMIC CHARACTERISTICS^c						
C _{iss}	Input Capacitance	V _{DS} =-15V, V _{GS} =0V, f=1MHz	-	504	-	PF
C _{oss}	Output Capacitance		-	68	-	
C _{rss}	Reverse Transfer Capacitance		-	56	-	
SWITCHING CHARACTERISTICS^c						
Q _g	Total Gate Charge	V _{DS} =-15V, I _D =-3.6A, V _{GS} =-10V	-	12	-	nC
Q _{gs}	Gate-Source Charge		-	2.3	-	
Q _{gd}	Gate-Drain Charge		-	1.4	-	
t _{d(on)}	Turn-on Delay Time	V _{DD} =-15V, R _L =5Ω, I _D =-3A, V _{GEN} =-10V, R _G =6Ω	-	8.1	-	nS
t _r	Turn-on Rise Time		-	3.3	-	
t _{d(off)}	Turn-off Delay Time		-	29.3	-	
t _f	Turn-off Fall Time		-	5.6	-	
Drain-Source Diode Characteristics						
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} =0V, I _S =-1.9A	-	-	-1.3	V

Note: Pulse Test: Pulse Width ≤300us, Duty Cycle ≤2%

-30V P-Channel MOSFET

Characteristics Curve

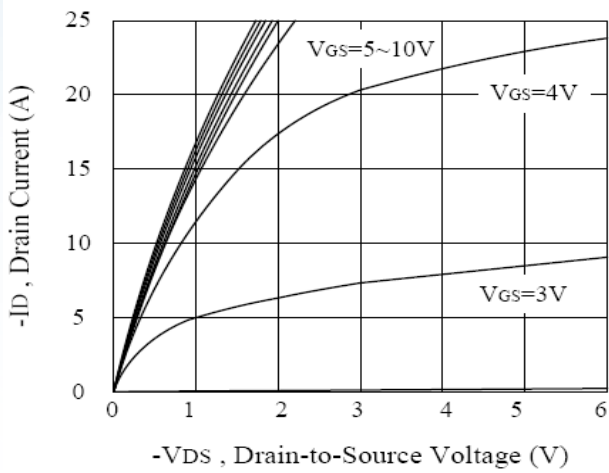


Figure 1. Output Characteristics

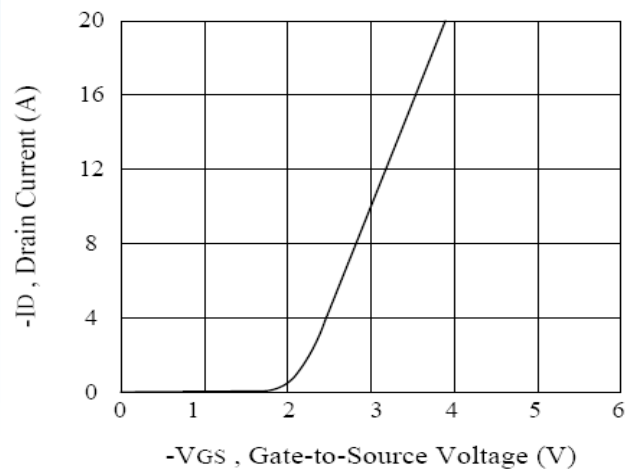


Figure 2. Transfer Characteristics

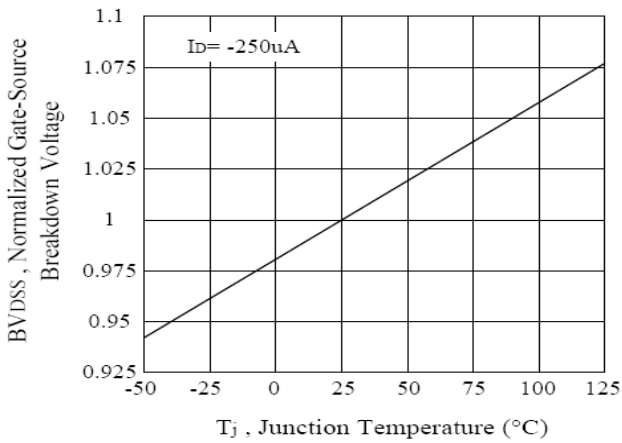


Figure 3. Breakdown Voltage Variation with Temperature

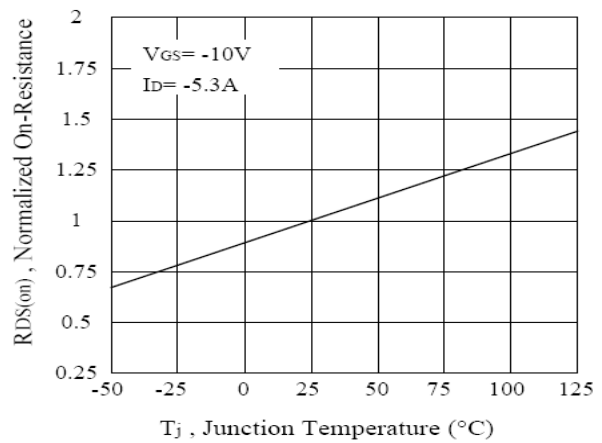


Figure 4. On-Resistance Variation with Temperature

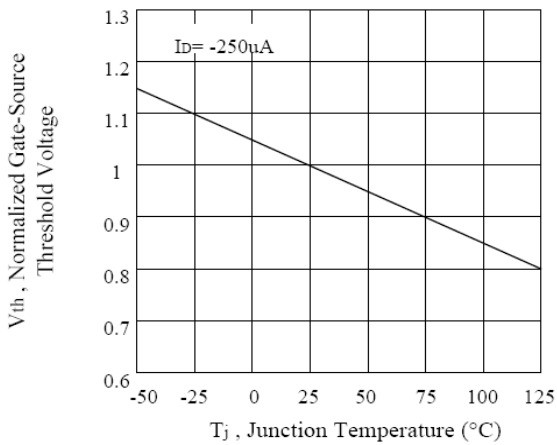


Figure 5. Gate Threshold Variation with Temperature

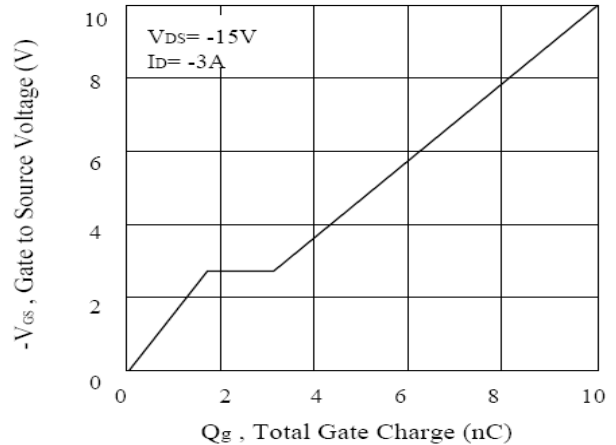
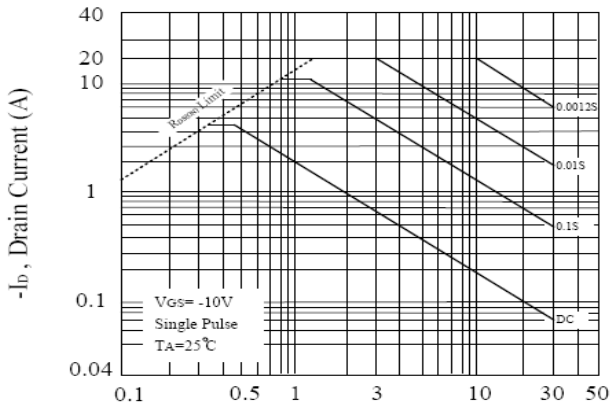


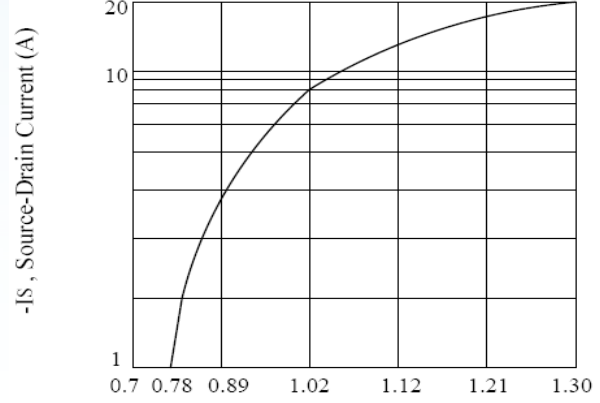
Figure 6. Gate Charge

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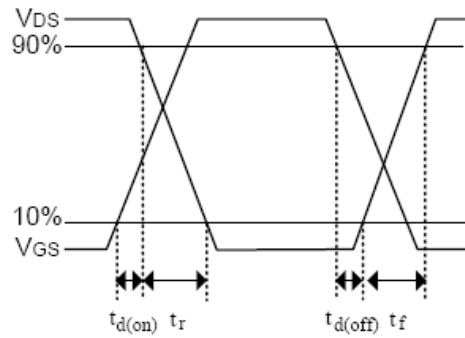
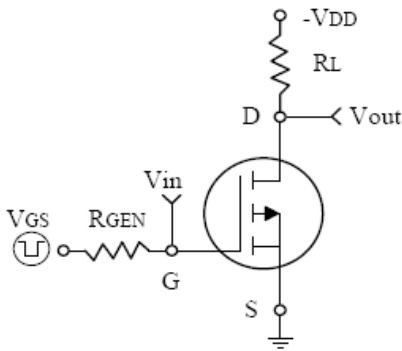
Characteristics Curve



-VDS, Drain-Source Voltage (V)
Figure 7. Maximum Safe Operating Area



-VSD, Body Diode Forward Voltage (V)
Figure 8. Body Diode Forward Voltage Variation with Source Current

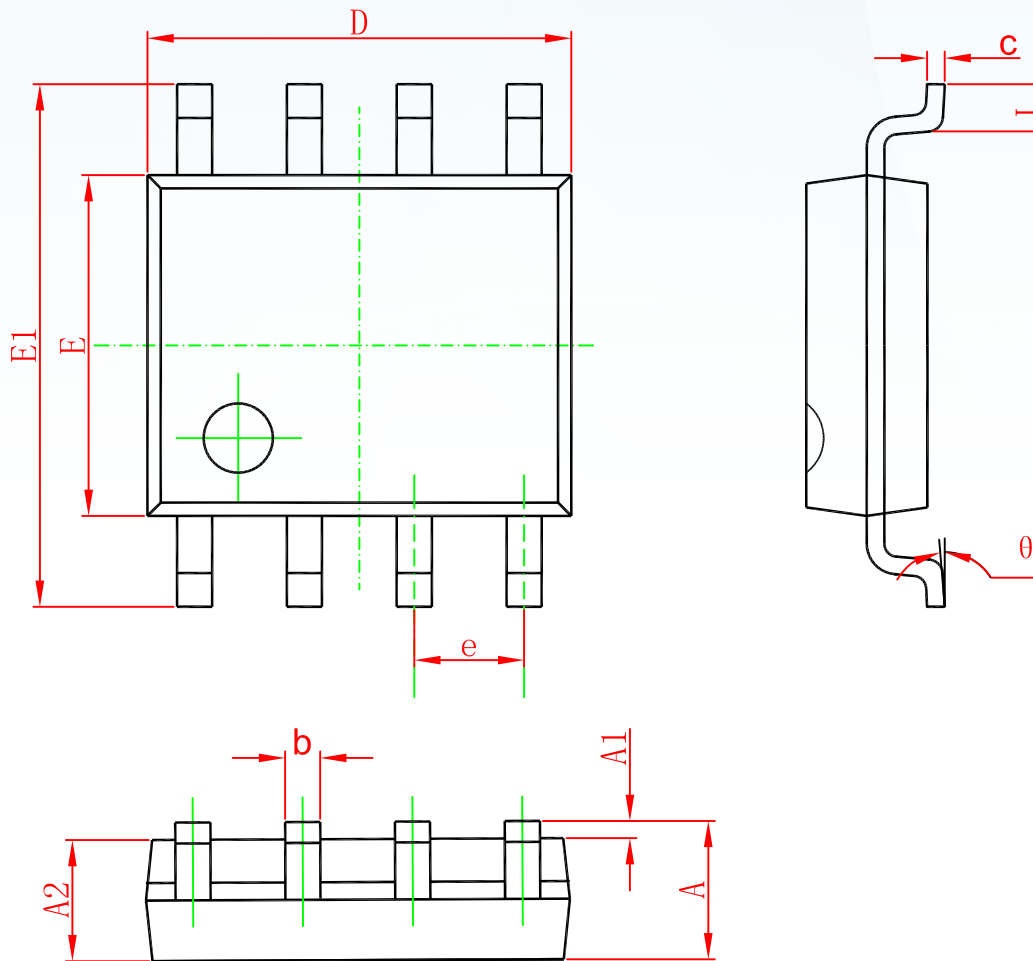


Switching Test Circuit and Switching Waveforms

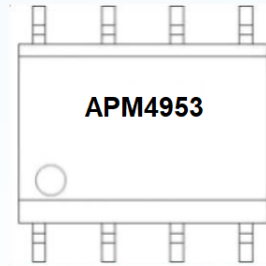
-30V P-Channel MOSFET

PACKAGE OUTLINE DIMENSIONS

SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

-30V P-Channel MOSFET**Marking****Ordering information**

Order code	Package	Baseqty	Deliverymode
APM4953	SOP-8	3000	Tape and reel

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